WFD7N65LFS Product Description

Silicon N-Channel MOSFET

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 Features 650V, 7A R_{DS(ON)} = 1.4Ω (Max.) @ V_{GS} = 10V, I_D = 3.5A Fast switching 100% avalanche tested Improved dv/dt capability RoHS and Halogen-Free Compliant 	 Application Switch Mode Power Supply (SMPS) Uninterruptible Power Supply (UPS) Power Factor Correction (PFC)
Package	

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Absolute Maximum Ratings Tc=25°C unless otherwise specified

Symbol	Parameter		Max.	Units
V _{DSS}	Drain-Source Voltage	Drain-Source Voltage		V
V _{GSS}	Gate-Source Voltage		± 30	V
ID	Continuous Drain Current note5	T _C = 25℃	7	Α
IDM	Pulsed Drain Current note3		28	Α
PD	Power Dissipation note2	T _C = 25℃	34.5	W
E _{AS}	Single Pulse Avalanche Energy note3.6		432	mJ
Rejc	Thermal Resistance, Junction to Case		1.4	°C/W
Reja	Thermal Resistance, Junction to Ambient note1,4		62.5	°C/W
TJ, TSTG	Operating and Storage Temperature Range		-55 to +150	°C

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Electrical Characteristics Tc=25 °C unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charact	eristic		•	•		
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	650	-	-	V
IDSS	Drain-Source Leakage Current	V _{DS} = 650V, V _{GS} = 0V	-	-	1	μA
lgss	Gate to Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	±100	nA
On Charact	eristics	·				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 3.5A	-	1.2	1.4	Ω
R _g	Gate Resistance	f = 1.0MHz	-	1.37	-	Ω
Dynamic Ch	naracteristics					
Ciss	Input Capacitance		-	1038	-	pF
Coss	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$	-	106	-	pF
Crss	Reverse Transfer Capacitance	f = 1.0MHz	-	15.3	-	pF
Switching C	Characteristics					
Qg	Total Gate Charge	N 500)/ L 404	-	32	-	nC
Q _{gs}	Gate-Source Charge	V_{DS} = 520V, I_{D} = 10A,	-	6.5	-	
Q _{gd}	Gate-Drain("Miller") Charge	V _{GS} = 7V	-	10.5	-	
t _{d(on)}	Turn-On Delay Time		-	11	-	
tr	Turn-On Rise Time	V _{DS} = 310V, I _D = 7A, R _G = 4.7Ω, V _{GS} =10V	-	17	-	ns
t _{d(off)}	Turn-Off Delay Time		-	30	-	
t _f	Turn-Off Fall Time		-	31	-	
Diode Char	acteristics					
Vsd	Diode Forward Voltage note3	Is=7A . V _{GS} = 0V	-	-	1.4	V
t _{rr}	Reverse Recovery Time	I _{SD} =7A, V _{GS} = 0V	-	411	-	ns
Qrr	Reverse Recovery Charge	dl _{sD} /dt=100A/µs	-	2.7	-	nC

Notes:

1. The value of $R_{\theta JC}$ is measured in a still air environment with TA =25°C and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

2. The power dissipation P_D is based on $T_{J(MAX)}=150^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

3. Single pulse width limited by junction temperature $T_{J(MAX)}$ =150°C.

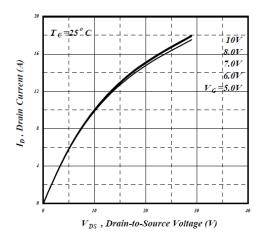
4. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.

5. The maximum current rating is package limited.

6. The EAS data shows Max. rating. The test condition is V_{DS} =100V, V_{GS} =10V,L=10mH

Silicon N-Channel MOSFET

Typical Performance Characteristics





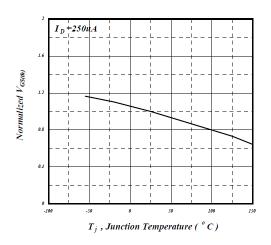


Figure 3. Normalized On Resistance vs Junction Temperature

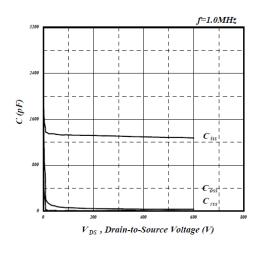


Figure 5. Capacitance Characteristics



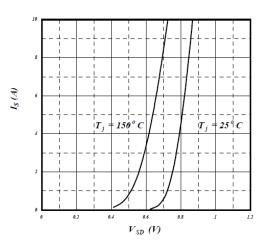


Figure 2. Body Diode Forward Voltage vs Source Current and Temperature

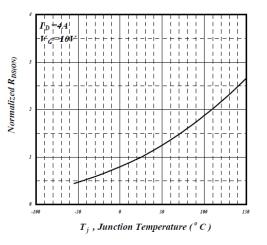


Figure 4. Normalized On Resistance vs Junction Temperature

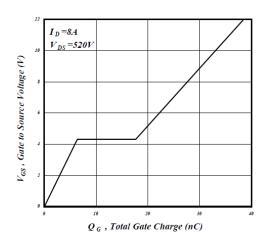


Figure 6. Gate Charge Characteristics

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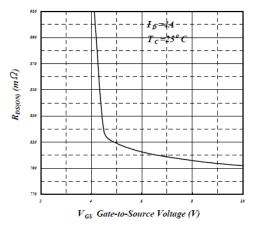


Figure 7. On-Resistance vs Gate Voltage

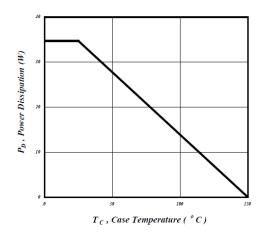
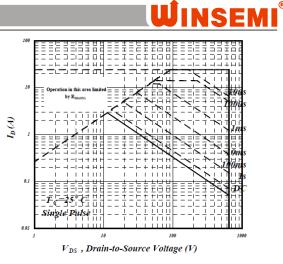
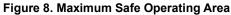


Figure 9. Total Power Dissipation





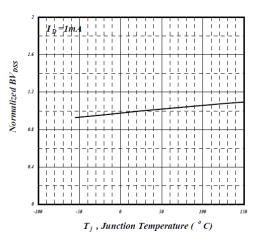


Figure 10. Normalized Breakdown Voltage vs Junction Temperature

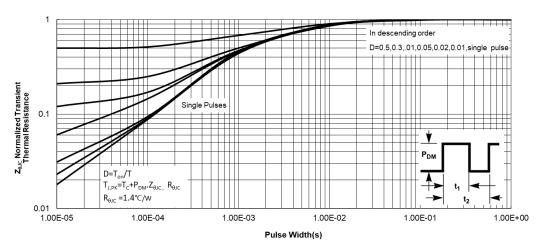
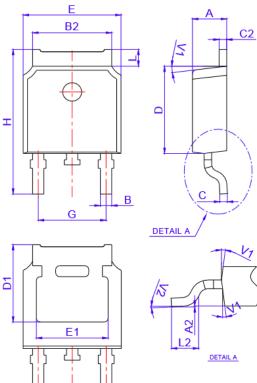


Figure 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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www.winsemi.com	Tel : +86-755-8250 6288	Fax : +86-755-8250 6299		4/6

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			Dime	ensions		
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF		0.209REF			
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

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NOTE:

1.We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.

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2.Please do not exceed the absolute maximum ratings of the device when circuit designing.

3. Winsemi Microelectronics Co., Ltd reserved the right to make changes in this specification sheet and is subject to change without prior notice.

CONTACT:

WINSEMI Microelectronics Co., Ltd.

ADD:Room 1002, East, Phase 2, HighTech Plaza, Tian-An Cyber Park, Che gong miao, FuTian, Shenzhen, P.R. China. Post Code : 518040 Tel: +86-755-8250 6288 FAX: +86-755-8250 6299 Web Site : www.winsemi.com